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SB120A thru SB160A

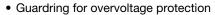
Vishay General Semiconductor

Schottky Barrier Rectifier



PRIMARY CHARACTERISTICS						
I _{F(AV)}	1.0 A					
V_{RRM}	20 V to 60 V					
I _{FSM}	35 A					
V_{F}	0.50 V, 0.70 V					
T _J max.	125 °C, 150 °C					

FEATURES





· Extremely fast switching

· Low forward voltage drop

• High frequency operation

• Solder dip 275 °C max. 10 s, per JESD 22-B106

• Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC



TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, dc-to-dc converters, and polarity protection applications.

MECHANICAL DATA

Case: DO-204AL (DO-41)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS compliant, commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	SB120A	SB130A	SB140A	SB150A	SB160A	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	V
Maximum RMS voltage	V _{RMS}	14	21	28	35	42	V
Maximum DC blocking voltage	V _{DC}	20 30 40 50 60		60	V		
Maximum average forward rectified current at 0.375" (9.5 mm) lead length (fig. 1)	I _{F(AV)}	1.0				Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	35			Α		
Voltage rate of change (rated V _R)	dV/dt	10 000			V/µs		
Operating junction temperature range	TJ	- 65 to + 125 - 65 to + 150			°C		
Storage temperature range	T _{STG}	- 65 to + 150			°C		

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)								
PARAMETER	TEST CONDITIO	NS SYMBOL	SB120A	SB130A	SB140A	SB150A	SB160A	UNIT
Maximum instantaneous forward voltage	1.0 A	V _F ⁽¹⁾		0.5		0.7		V
Maximum reverse current	$T_A = 25^{\circ}$	C I _R ⁽²⁾	0.5			mA		
at rated V _R	$T_A = 100$	°C 'R (-)		10		5		

Notes

 $^{(1)}$ Pulse test: 300 μ s pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

SB120A thru SB160A

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THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	SB120A	SB130A	SB140A	SB150A	SB160A	UNIT
Typical thermal resistance	R _{0JA} (1)	100					°C/W
Typical triefmai resistance	R _{0JL} (1)	30					C/VV

Note

(1) Thermal resistance from junction to lead P.C.B. mounting 0.375" (9.5 mm) lead length

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
SB140A-E3/54	0.34	54	5500	13" diameter paper tape and reel				
SB140A-E3/73	0.34	73	3000	Ammo pack packaging				

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

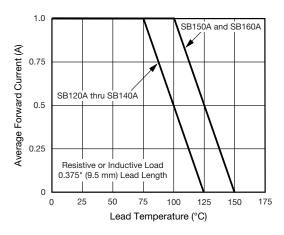


Fig. 1 - Forward Current Derating Curve

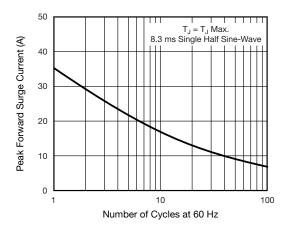


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

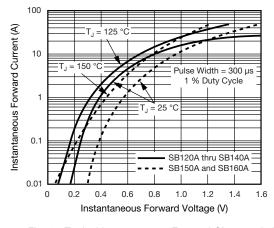


Fig. 3 - Typical Instantaneous Forward Characteristics

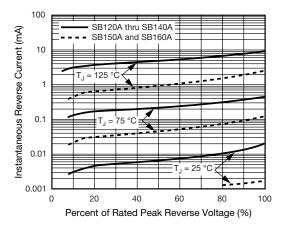


Fig. 4 - Typical Reverse Characteristics





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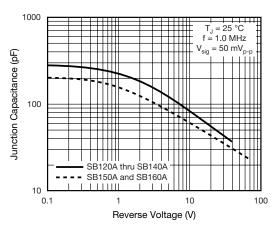


Fig. 5 - Typical Junction Capacitance

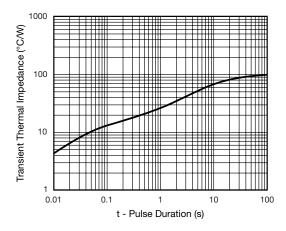
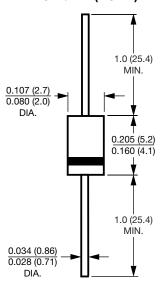


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-204AL (DO-41)





Vishay

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Document Number: 91000 Revision: 18-Jul-08